Declaration For U.S. Patent Application

As a below named inventor, I hereby declare that:

•]	My residence, post office address and citizenship are as stated below next to my name.												
I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plura names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled (Insert Title)													
			FOR FORMING METAL		SURFACE O	F RESIN	MOLDED	PRODUCT					
. 1	the specification of which is attached hereto unless the following is checked:												
		was files	lon		as I Imited States	A-mlinesia- 1	NT 1	ocan t					
		was filed on		•••••••••••••••••••••••••••••••••••••••									
			Application Number		and was amended on								
		(if applicable).											
] }	I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claim(s), as amended by any amendment referred to above.												
]	acknowledge t	the duty to	disclose information which is materia	al to patentabilit	y as defined in Ti	tle 37, Code	of Federal R	egulations, § 1.56.					
-	inventor's certi- ing date before	ficate listed	ority benefits under Title 35, United below and have also identified below application on which priority is claim	ow any foreign	119 (a) - (d) of a application for pa	ny foreign ap atent or inven	plication(s) tor's certific	for patent or cate having a fil-					
8) 290 a	(List prior foreign applications.		11-121170	Japan		28/April/1	999	Priority Claimed Yes No					
100			(Number)	(Country) (I	Day/Month/Y	ear Filed)	-					
to mean made. Many many			(Number)	(Country	<u> </u>	Day/Month/Y	ear Filed)	_ Q Yes Q No					
	See note A on back of				·		•	_ 🔾 Yes 🗘 No					
	this page)		(Number)	(Country) (I	Day/Month/Y	ear Filed)	_ □ Yes □ No					
		4-1-4	(Number)	(Country) (I	Day/Month/Y	ear Filed)	_					
(See note B on	back of this	s page)	list for addition	al prior foreign a	pplications							
I	hereby claim t	the benefit	under Title 35, United States Code,	§ 119(e) of any	United States pr	ovisional app	olication(s) l	isted below.					
	(Application Number)				(F)	lling Date)		_					
			(Application Number)		(Fi	iling Date)		-					
t i	subject matter o he first paragra ty as defined in	of each of the oph of Title on Title 37, (under Title 35, United States Code, he claims of this application is not of 35, United States Code, § 112, I accorded to Federal Regulations, § 1.56 ternational filing date of the applications.	lisclosed in the knowledge the o which became	prior United Stat duty to disclose i	es application of the filing d	n in the man hich is mate	ner provided by erial to patentabil-					
	VT 1 2 75 1 ==		(Application Serial Number)	(Eiling Do	to)	(Status) (==t=							
	(List Prior U. Applications)			(Filing Da	——— ——	(Status) (pate	nted, pendin	g, abandoned)					
			(Application Serial Number)	(Filing Da	te)	(Status) (pate	nted, pendin	ig, abandoned)					

I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith:

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I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Title 18 of the United States Code, § 1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

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	nature						
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'ull name of	seventh inventor (given na	me, family name)					
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